

June 1988 Revised October 1998

74ACT323

8-Bit Universal Shift/Storage Register with Synchronous Reset and Common I/O Pins

General Description

The ACT323 is an 8-bit universal shift/storage register with 3-STATE outputs. Parallel load inputs and flip-flop outputs are multiplexed to minimize pin count. Separate serial inputs and outputs are provided for Q_0 and Q_7 to allow easy cascading. Four operation modes are possible: hold (store), shift left, shift right and parallel load.

Features

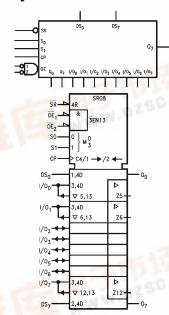
- I_{CC} and I_{OZ} reduced by 50%
- Common parallel I/O for reduced pin count
- Additional serial inputs and outputs for expansion
- Four operating modes: shift left, shift right, load and
- 3-STATE outputs for bus-oriented applications
- Outputs source/sink 24 mA
- TTL-compatible inputs

Ordering Code:

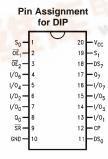
Order Number	Package Number	Package Description
74ACT323PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Pin Descriptions

Pin Name	Description Description				
CP	Clock Pulse Input				
DS ₀	Serial Data Input for Right Shift				
DS ₇	Serial Data Input for Left Shift				
S ₀ , S ₁	Mode Select Inputs				
SR	Synchronous Reset Input				
\overline{OE}_1 , \overline{OE}_2	3-STATE Output Enable Inputs				
I/O ₀ -I/O ₇	Multiplexed Parallel Data Inputs or				
	3-STATE Parallel Data Outputs				
Q ₀ , Q ₇	Serial Outputs				

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Functional Description

The ACT323 contains eight edge-triggered D-type flip-flops and the interstage logic necessary to perform synchronous reset, shift left, shift right, parallel load and hold operations. The type of operation is determined by \mathbf{S}_0 and \mathbf{S}_1 as shown in the Mode Select Table. All flip-flop outputs are brought out through 3-STATE buffers to separate I/O pins that also serve as data inputs in the parallel load mode. Q₀ and Q₇ are also brought out on other pins for expansion in serial shifting of longer words.

A LOW signal on $\overline{\rm SR}$ overrides the Select inputs and allows the flip-flops to be reset by the next rising edge of CP. All other state changes are also initiated by the LOW-to-HIGH CP transition. Inputs can change when the clock is in either state provided only that the recommended setup and hold times, relative to the rising edge of CP, are observed.

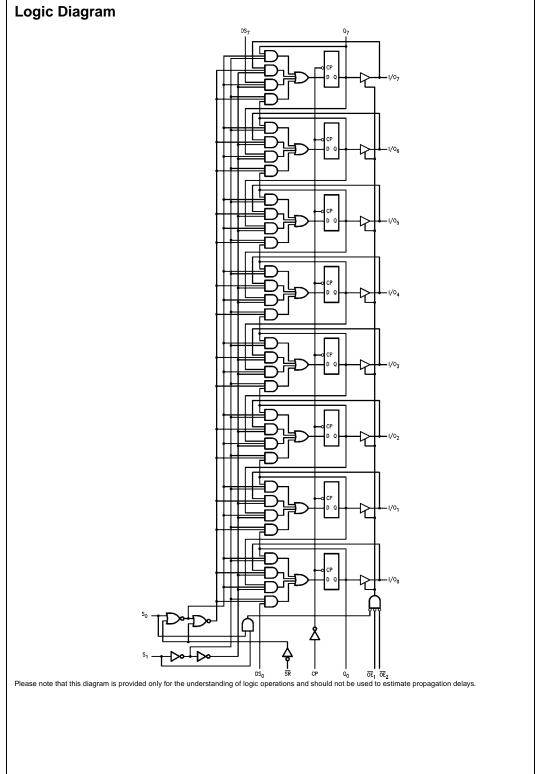
A HIGH signal on either $\overline{\rm OE}_1$ or $\overline{\rm OE}_2$ disables the 3-STATE buffers and puts the I/O pins in the high impedance state. In this condition the shift, load, hold and reset operations can still occur. The 3-STATE buffers are also disabled by HIGH signals on both S_0 and S_1 in preparation for a parallel load operation.

Mode Select Table

Inputs				Response			
SR	S ₁	S ₀	CP				
L	Х	Х	_	Synchronous Reset; Q ₀ –Q ₇ = LOW			
Н	Н	Н	~	Parallel Load; I/O _n →Q _n			
Н	L	Н	~	Shift Right; $DS_0 \rightarrow Q_0$, $Q_0 \rightarrow Q_1$, etc.			
Н	Н	L	~	Shift Left; $DS_7 \rightarrow Q_7$, $Q_7 \rightarrow Q_6$, etc.			
Н	L	L	Х	Hold			

H = HIGH Voltage Level

L = LOW Voltage Level X = Immaterial



Absolute Maximum Ratings(Note 1)

Supply Voltage (V_{CC}) -0.5V to +7.0V

DC Input Diode Current (I_{IK})

 $\begin{array}{c} \text{V}_{\text{I}} = -0.5 \text{V} & -20 \text{ mA} \\ \text{V}_{\text{I}} = \text{V}_{\text{CC}} + 0.5 \text{V} & +20 \text{ mA} \\ \text{DC Input Voltage (V_{\text{I}})} & -0.5 \text{V to V}_{\text{CC}} + 0.5 \text{V} \end{array}$

DC Output Diode Current (I_{OK})

$$\begin{split} \text{V}_{\text{O}} = -0.5 \text{V} & -20 \text{ mA} \\ \text{V}_{\text{O}} = \text{V}_{\text{CC}} + 0.5 \text{V} & +20 \text{ mA} \end{split}$$

DC Output Voltage (V_O) -0.5V to $V_{CC} + 0.5V$

DC Output Source or

Sink Current (I_O) ±50 mA

DC V_{CC} or Ground Current

Per Output Pin (I_{CC} or I_{GND}) ± 50 mA Storage Temperature (T_{STG}) -65° C to $+150^{\circ}$ C

Junction Temperature (T_J)

140°C

Recommended Operating Conditions

Minimum Input Edge Rate ($\Delta V/\Delta t$)

 V_{IN} from 0.8V to 2.0V

 $V_{CC} @ 4.5V, 5.5V$ 125 mV/ns

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}	$T_A = +25^{\circ}C$		T _A = -40°C to +85°C	Units	Conditions	
		(V)	Typ Gu		aranteed Limits			
V _{IH}	Minimum High Level	4.5	1.5	2.0	2.0	V	V _{OUT} = 0.1V	
	Input Voltage	5.5	1.5	2.0	2.0		or V _{CC} – 0.1V	
V _{IL}	Maximum Low Level	4.5	1.5	0.8	0.8	V	V _{OUT} = 0.1V	
	Input Voltage	5.5	1.5	0.8	0.8		or V _{CC} – 0.1V	
V _{OH}	Minimum High Level	4.5	4.49	4.4	4.4	V	$I_{OUT} = -50 \mu A$	
	Output Voltage	5.5	5.49	5.4	5.4			
							$V_{IN} = V_{IL}$ or V_{IH}	
		4.5		3.86	3.76	V	$I_{OH} = -24 \text{ mA}$	
		5.5		4.86	4.76		$I_{OH} = -24 \text{ mA (Note 2)}$	
V _{OL}	Maximum Low Level	4.5	0.001	0.1	0.1	V	I _{OUT} = 50 μA	
	Output Voltage	5.5	0.001	0.1	0.1			
							$V_{IN} = V_{IL}$ or V_{IH}	
		4.5		0.36	0.44	V	$I_{OL} = -24 \text{ mA}$	
		5.5		0.36	0.44		I _{OL} = -24 mA (Note 2)	
I _{IN}	Maximum Input	5.5		±0.1	±1.0	μΑ	$V_I = V_{CC}$, GND	
	Leakage Current							
I _{OZT}	Maximum I/O	5.5		±0.3	±3.0	μΑ	$V_{I/O} = V_{CC}$ or GND	
	Leakage Current						$V_{IN} = V_{IH}, \ V_{IL}$	
I _{CCT}	Maximum I _{CC} /Input	5.5	0.6		1.5	mA	$V_{I} = V_{CC} - 2.1V$	
I _{OLD}	Minimum Dynamic	5.5			75	mA	V _{OLD} = 1.65V Max	
I _{OHD}	Output Current (Note 3)	5.5			-75	mA	V _{OHD} = 3.85V Min	
I _{CC}	Maximum Quiescent	5.5		4.0	40.0	μΑ	$V_{IN} = V_{CC}$ or GND	
	Supply Current			1				

Note 2: All outputs loaded; thresholds on input associated with output under test.

Note 3: Maximum test duration 2.0 ms, one output loaded at a time.

AC Electrical Characteristics

	Parameter	V _{CC}	V_{CC} $T_A = 25^{\circ}C$				$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		
Symbol		(V)	$C_L = 50 \text{ pF}$			$C_L = 50 \ pF$		Units	
		(Note 4)	Min	Тур	Max	Min	Max		
f _{max}	Maximum Input Frequency	5.0	120	125		110		MHz	
t _{PLH}	Propagation Delay	5.0	5.0	9.0	12.5	4.0	14.0	ns	
	CP to Q ₀ or Q ₇								
t _{PHL}	Propagation Delay	5.0	5.0	9.0	13.5	4.5	15.0	ns	
	CP to Q ₀ or Q ₇								
t _{PLH}	Propagation Delay	5.0	5.0	8.5	12.5	4.5	14.5	ns	
	CP to I/O _n								
t _{PHL}	Propagation Delay	5.0	6.0	10.0	14.5	5.0	16.0	ns	
	CP to I/O _n								
t _{PZH}	Output Enable Time	5.0	3.5	7.5	11.0	3.0	12.5	ns	
t _{PZL}	Output Enable Time	5.0	3.5	7.5	11.5	3.0	13.0	ns	
t _{PHZ}	Output Disable Time	5.0	4.0	8.5	12.5	3.0	13.5	ns	
t _{PLZ}	Output Disable Time	5.0	3.0	8.0	11.5	2.5	12.5	ns	

Note 4: Voltage Range 5.0 is 5.0V ±0.5V

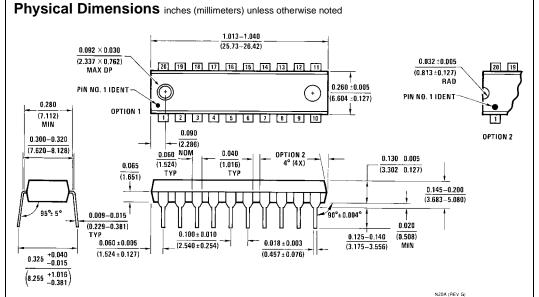
AC Operating Requirements

	Parameter		$T_A = 25^{\circ}C$ $C_L = 50 \text{ pF}$		$T_A = -40^{\circ}C$ to $+85^{\circ}C$		
Symbol		v _{cc}			C _L = 50 pF	Units	
		(V)	V _{CC} =	+5.0V	$V_{CC} = +5.0V$		
		(Note 5)	Тур	Gua	ranteed Minimum		
t _S	Setup Time, HIGH or LOW	5.0	2.0	5.0	5.0	ns	
	S ₀ or S ₁ to CP						
t _H	Hold Time, HIGH or LOW	5.0	0	1.5	1.5	ns	
	S ₀ or S ₁ to CP						
t _S	Setup Time, HIGH or LOW	5.0	1.0	4.0	4.5	ns	
	I/O _n , DS ₀ , DS ₇ to CP						
t _H	Hold Time, HIGH or LOW	5.0	0	1.0	1.0	ns	
	I/O _n , DS ₀ , DS ₇ to CP						
t _S	Setup Time, HIGH or LOW	5.0	1.0	2.5	2.5	ns	
	SR to CP						
t _H	Hold Time, HIGH or LOW	5.0	0	1.0	1.0	ns	
	SR to CP						
t _W	CP Pulse Width	5.0	2.0	4.0	4.5	ns	
	HIGH or LOW						

Note 5: Voltage Range 5.0 is 5.0V ±0.5V

Capacitance

Symbol	Parameter	Тур	Units	Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = OPEN
C _{PD}	Power Dissipation Capacitance	170	pF	V _{CC} = 5.0V



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide Package Number N20A

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